

## Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
150V	6.2mΩ@10V	140A



**合肥矽普半导体**

*Siliup Semiconductor Technology Co., Ltd*

技术 品质 服务

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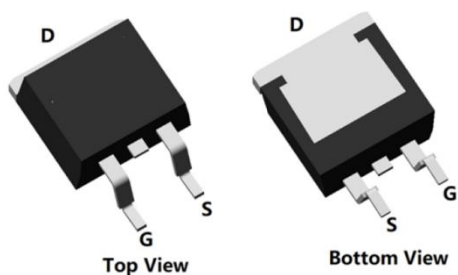
## Feature

- Fast Switching
- Low Gate Charge and  $R_{DS(on)}$
- Advanced Split Gate Trench Technology
- 100% Single Pulse avalanche energy Test

## Applications

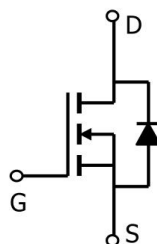
- Power switching application
- DC-DC Converter
- Power Management

## Package

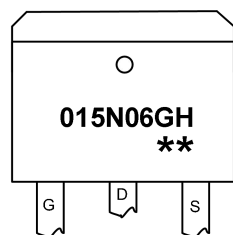


TO-263(1:G 2:D 3:S)

## Circuit diagram



## Marking



015N06GH : Device Code  
\*\* : Week Code

## Order Information

Device	Package	Unit/Tape
SP015N06GHTD	TO-263	800

**Absolute maximum ratings (Ta=25°C, unless otherwise noted)**

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	150	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current (Tc=25°C)	$I_D$	140	A
Continuous Drain Current (Tc=100°C)	$I_D$	95	A
Pulsed Drain Current	$I_{DM}$	560	A
Single Pulse Avalanche Energy <sup>1</sup>	$E_{AS}$	812	mJ
Power Dissipation (Tc=25°C)	$P_D$	230	W
Thermal Resistance Junction-to-Case	$R_{\theta JC}$	0.54	°C/W
Storage Temperature Range	$T_{STG}$	-55 to 150	°C
Operating Junction Temperature Range	$T_J$	-55 to 150	°C

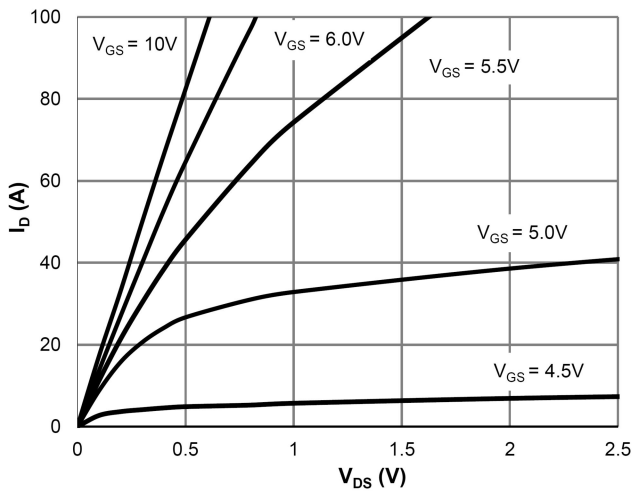
**Electrical characteristics (Ta=25°C, unless otherwise noted)**

Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	B <sub>V</sub> DSS	ID = 250μA, VGS = 0V	150	-	-	V
Drain Cut-Off Current	IDSS	VDS = 120V, VGS = 0V	-	-	1	μA
Gate Leakage Current	IGSS	VGS = ±20V, VDS = 0V	-	-	±0.1	
Gate Threshold Voltage	VGS(th)	VDS = VGS, ID = 250μA	2.0	3.0	4.0	V
Drain-Source ON Resistance	RDS(ON)	VGS = 10V, ID = 20A	-	6.2	7.5	mΩ
Dynamic Characteristics						
Input Capacitance	Ciss	VDS = 75V, VGS = 0V, f = 1.0MHz	-	5240	-	pF
Output Capacitance	Coss		-	430	-	
Reverse Transfer Capacitance	Crss		-	14	-	
Total Gate Charge	Qg	VDS=75V , VGS=10V , ID=70A	-	70	-	nC
Gate-Source Charge	Qgs		-	31	-	
Gate-Drain Charge	Qgd		-	20	-	
Switching Characteristics						
Turn-On Delay Time	td(on)	VGS = 10V, VDS = 50V, ID = 70A RG = 6Ω	-	24	-	nS
Rise Time	tr		-	35	-	
Turn-Off Delay Time	td(off)		-	46	-	
Fall Time	tf		-	15	-	
Drain-Source Body Diode Characteristics						
Source-Drain Diode Forward Voltage	VSD	IS = 1A, VGS = 0V	-	-	1.2	V
Maximum Body-Diode Continuous Current	IS		-	-	140	A
Body Diode Reverse Recovery Time	Trr	IS=50A, di/dt=100A/us, TJ=25℃	-	98	-	nS
Body Diode Reverse Recovery Charge	Qrr		-	217	-	nC

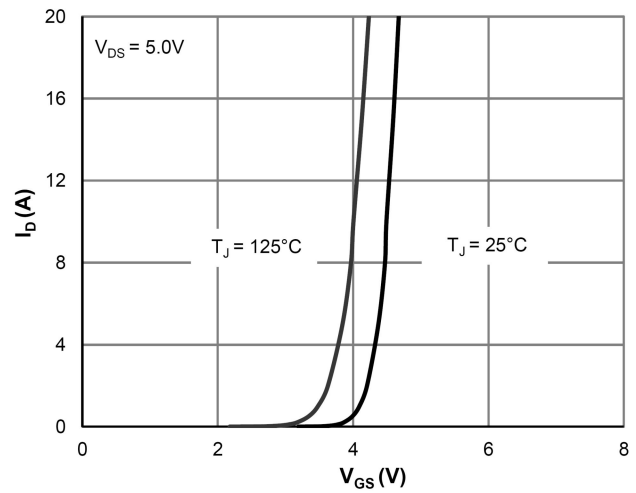
**Note :**

1. The test condition is  $V_{DD}=50V, V_{GS}=10V, L=0.5mH, R_G=25\Omega$ ;

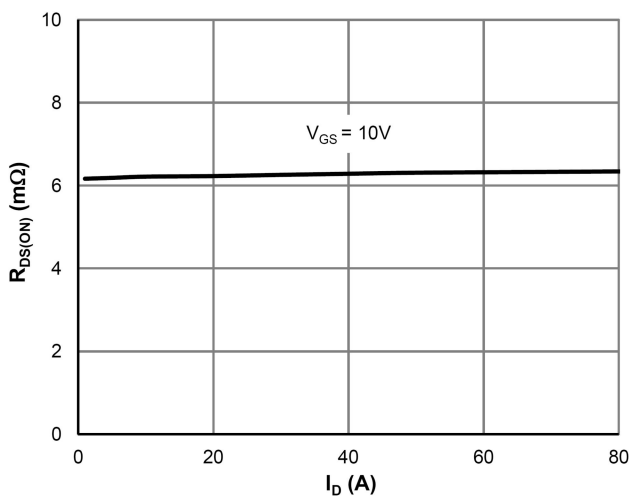
## Typical Characteristics



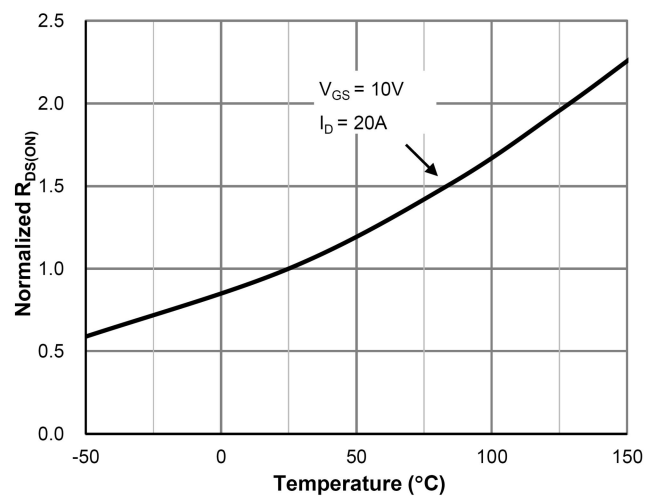
Saturation Characteristics



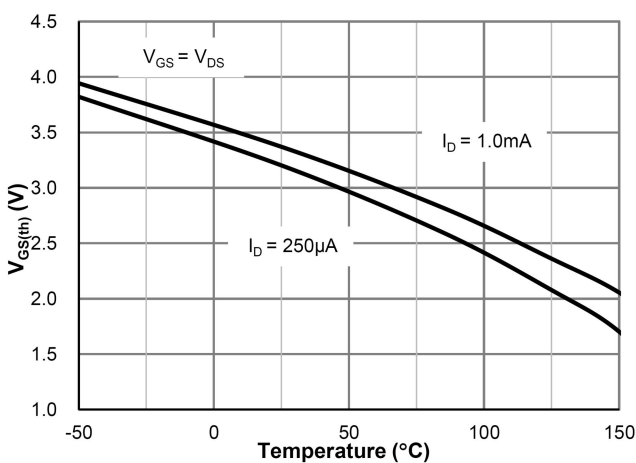
Transfer Characteristics



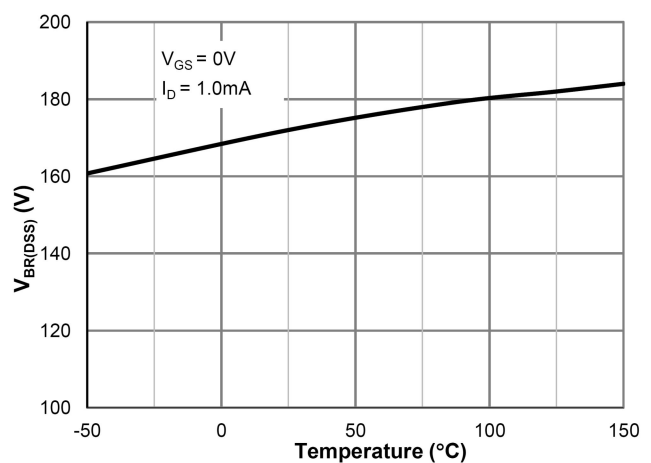
$R_{DS(ON)}$  vs. Drain Current



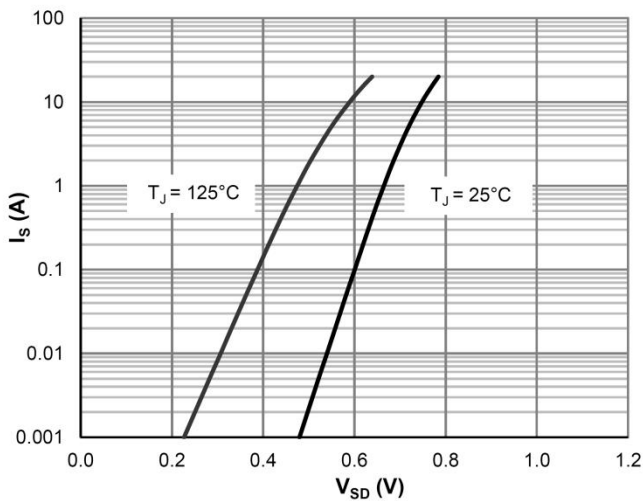
$R_{DS(ON)}$  vs. Junction Temperature



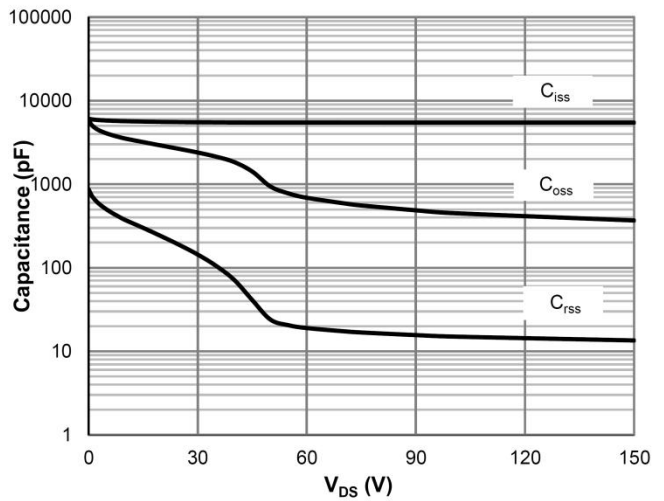
$V_{GS(th)}$  vs. Junction Temperature



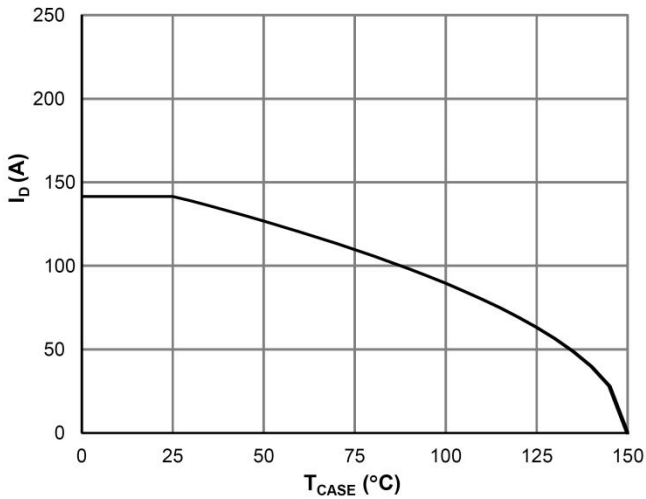
$V_{BR(DSS)}$  vs. Junction Temperature



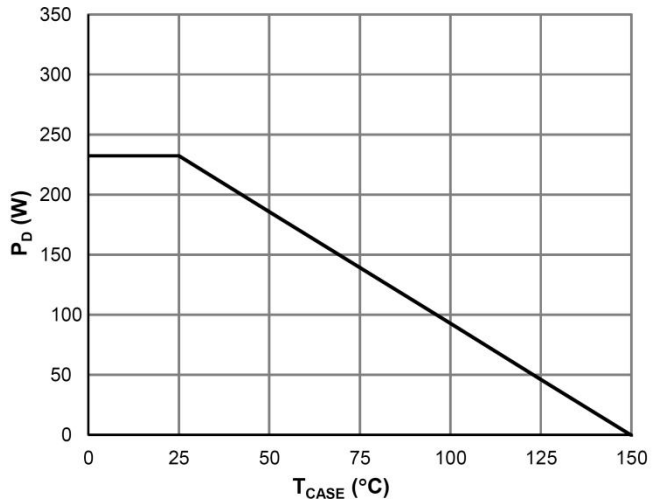
Body-Diode Characteristics



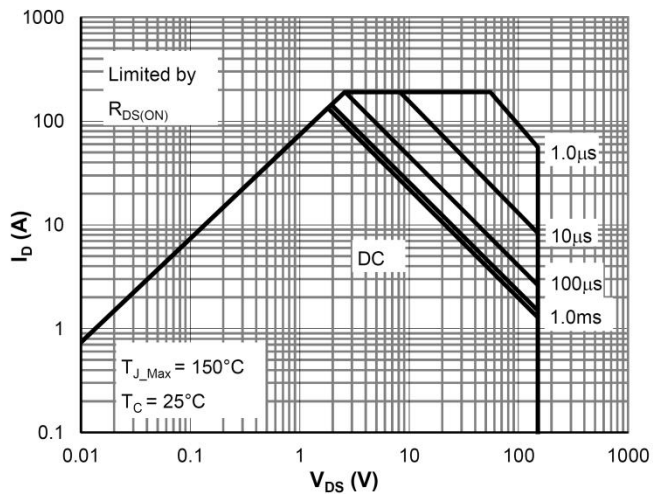
Capacitance Characteristics



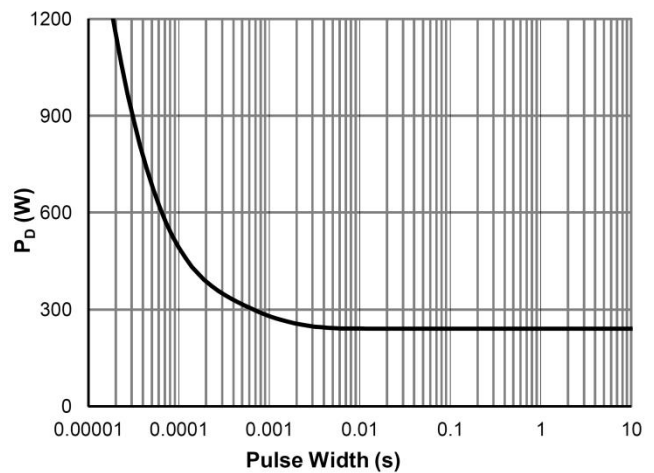
Current De-rating



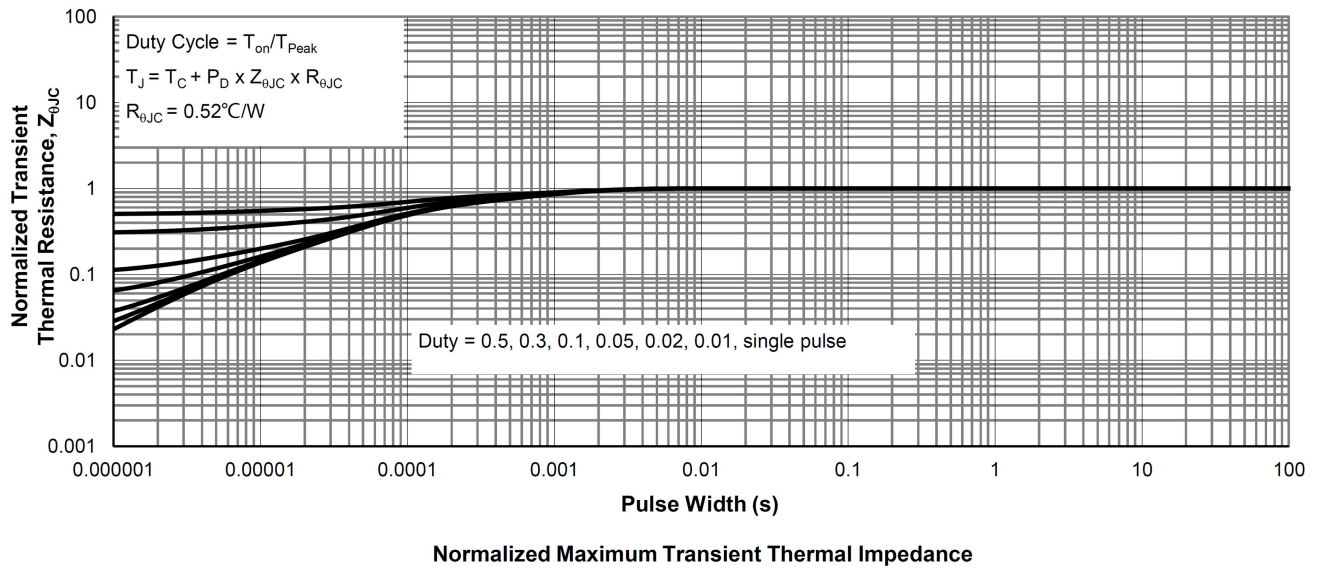
Power De-rating

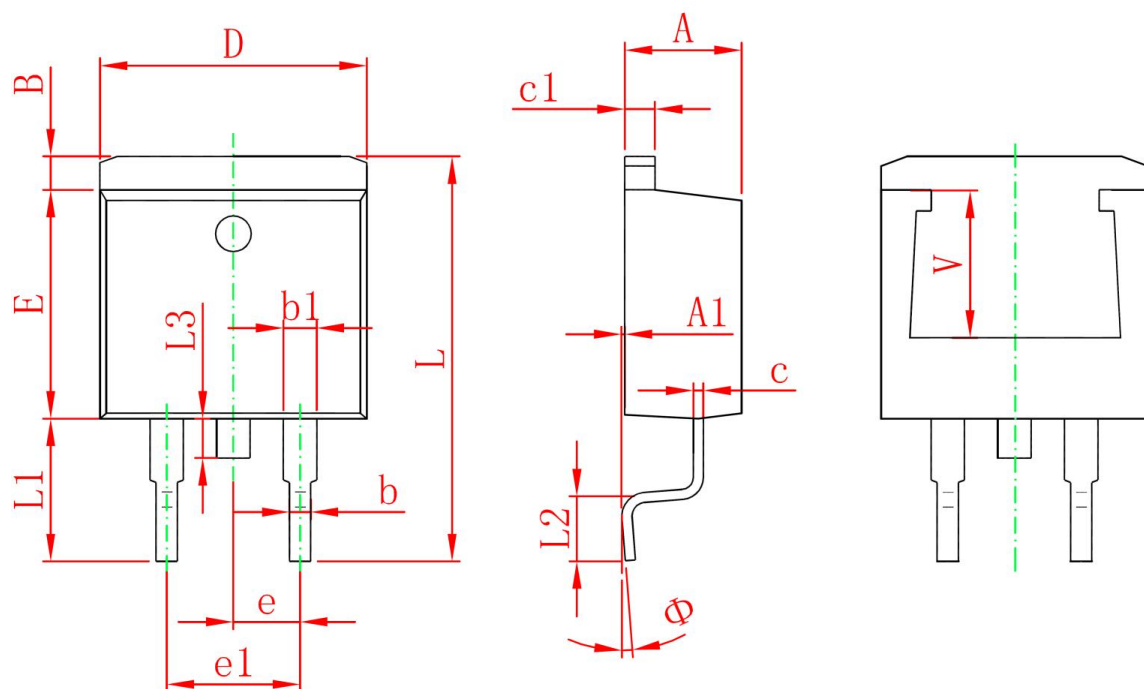


Maximum Safe Operating Area



Single Pulse Power Rating, Junction-to-Case



**TO-263 Package Information**


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.470	4.670	0.176	0.184
A1	0.000	0.150	0.000	0.006
B	1.120	1.420	0.044	0.056
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.310	0.530	0.012	0.021
c1	1.170	1.370	0.046	0.054
D	10.010	10.310	0.394	0.406
E	8.500	8.900	0.335	0.350
e	2.540 TYP.		0.100 TYP.	
e1	4.980	5.180	0.196	0.204
L	14.940	15.500	0.588	0.610
L1	4.950	5.450	0.195	0.215
L2	2.340	2.740	0.092	0.108
L3	1.300	1.700	0.051	0.067
Φ	0°	8°	0°	8°
V	5.600 REF.		0.220 REF.	